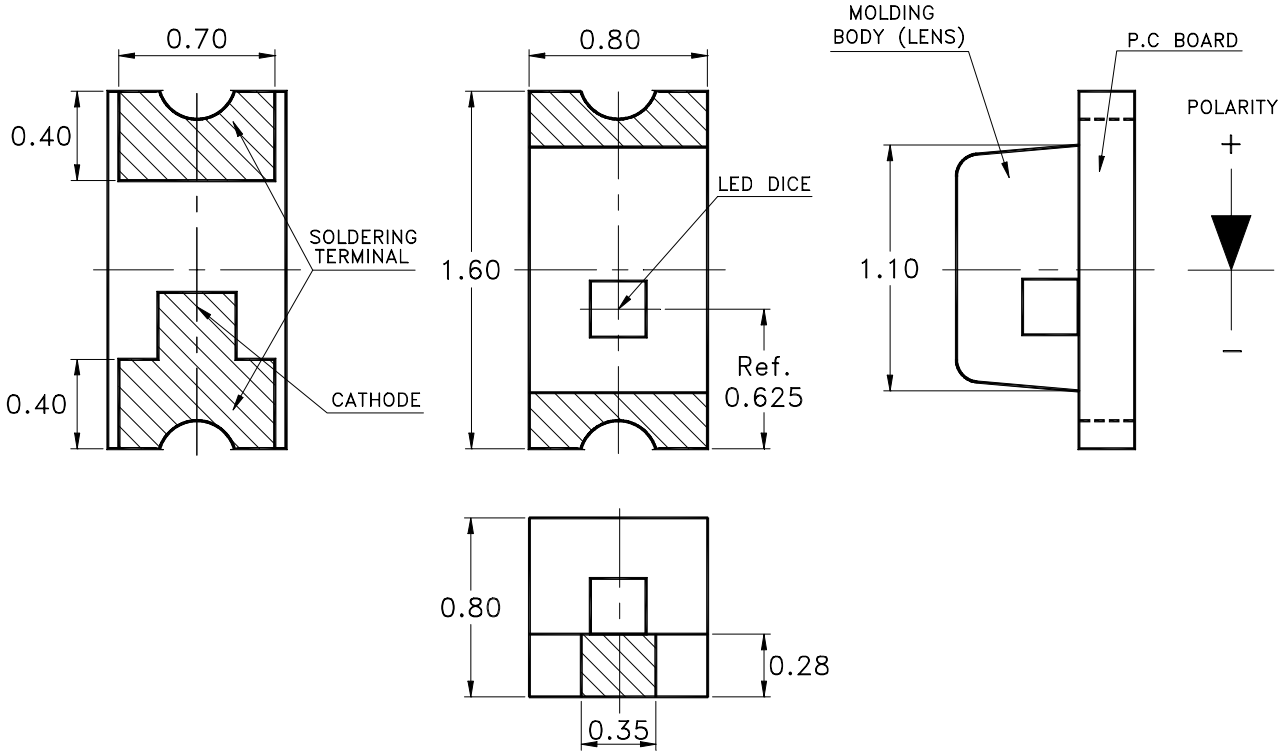
Features

* Package In 8mm Tape On 7" Diameter Reels.
* Compatible With Automatic Placement Equipment.
* Compatible With Infrared And Vapor Phase Reflow Solder Process.
* EIA STD package.
* I.C. compatible.

Package Dimensions



Part No.	Lens	Source Color
LTST-C190AKT	Water Clear	GaAsP on GaP Orange

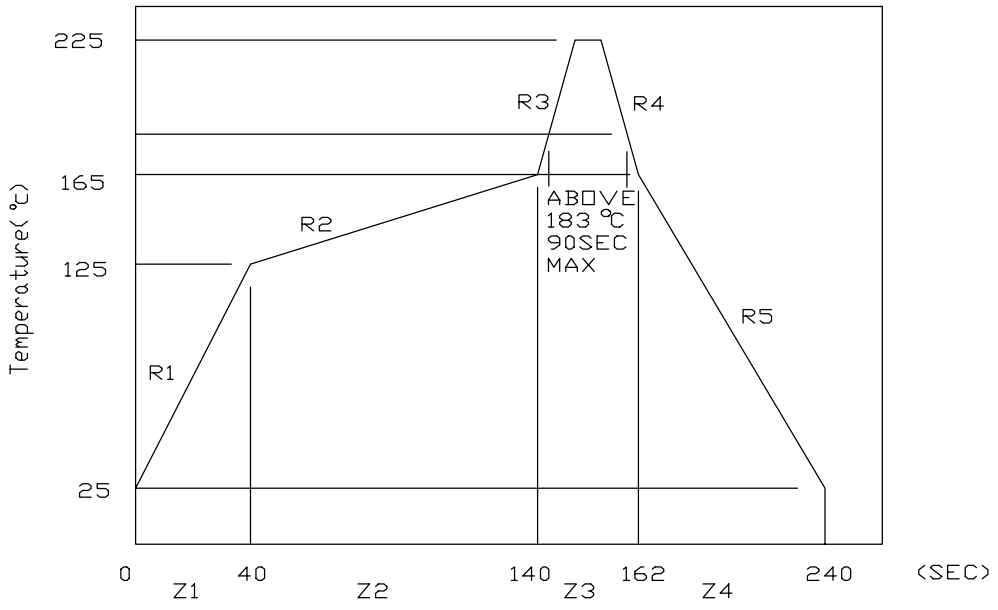
Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is ± 0.10 mm (.004") unless otherwise noted.

Absolute Maximum Ratings At Ta=25℃

Parameter	LTST-C190AKT	Unit
Power Dissipation	100	mW
Peak Forward Current (1/10 Duty Cycle, 0.1ms Pulse Width)	120	mA
Continuous Forward Current	30	mA
Derating Linear From 50℃	0.6	mA/℃
Reverse Voltage	5	V
Operating Temperature Range	-55℃ to + 85℃	
Storage Temperature Range	-55℃ to + 85℃	
Wave Soldering Condition	260°C For 5 Seconds	
Infrared Soldering Condition	260°C For 5 Seconds	
Vapor Phase Soldering Condition	215°C For 3 Minutes	

Suggest IR Reflow Condition :



Electrical Optical Characteristics At Ta=25℃

Parameter	Symbol	Part No. LTST-	Min.	Typ.	Max.	Unit	Test Condition
Luminous Intensity	IV	C190AKT	1.0	2.0		mcd	IF = 10mA Note 1
Viewing Angle	2θ 1/2	C190AKT		130		deg	Note 2 (Fig.6)
Peak Emission Wavelength	λ P	C190AKT		610		nm	Measurement @Peak (Fig.1)
Dominant Wavelength	λ d	C190AKT		602		nm	Note 3
Spectral Line Half-Width	Δ λ	C190AKT		35		nm	
Forward Voltage	VF	C190AKT		2.1	2.6	V	IF = 20mA
Reverse Current	IR	C190AKT			100	μA	VR = 5V
Capacitance	C	C190AKT		15		PF	VF = 0 f = 1MHZ

Notes: 1. Luminous intensity is measured with a light sensor and filter combination that approximates the CIE eye-response curve.

2. θ 1/2 is the off-axis angle at which the luminous intensity is half the axial luminous intensity.

3. The dominant wavelength, λ d is derived from the CIE chromaticity diagram and represents the single wavelength which defines the color of the device.

Bin Code List

Luminous Intensity	Unit : mcd @10mA	
Bin Code	Min.	Max.
F	1.0	2.0
G	1.6	3.2
H	2.5	5.0
J	4.0	8.0
K	6.3	12.5

Typical Electrical / Optical Characteristics Curves

(25 °C Ambient Temperature Unless Otherwise Noted)

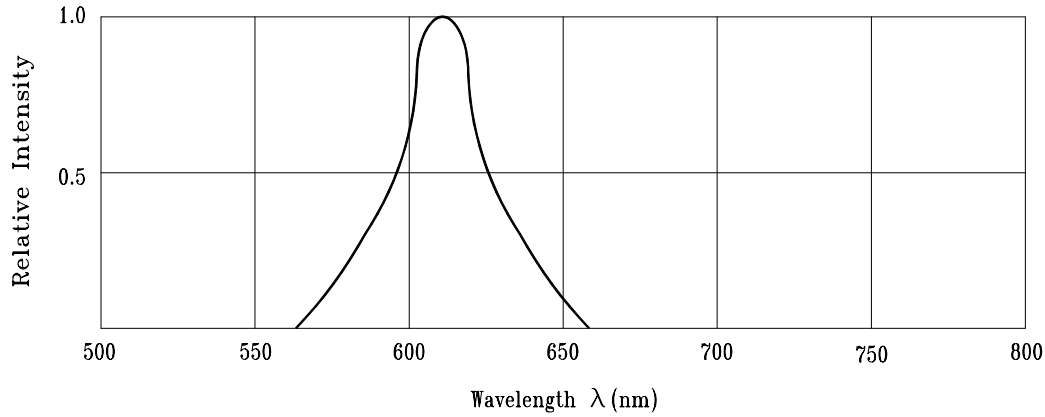


Fig.1 RELATIVE INTENSITY VS. WAVELENGTH

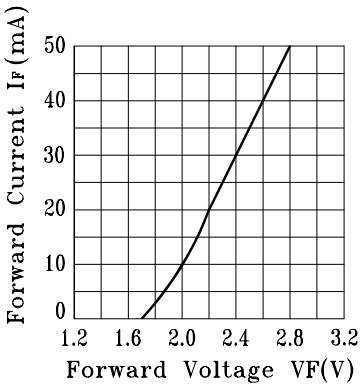


Fig.2 FORWARD CURRENT VS. FORWARD VOLTAGE

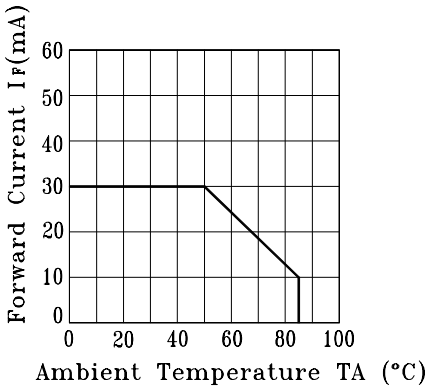


Fig.3 FORWARD CURRENT DERATING CURVE

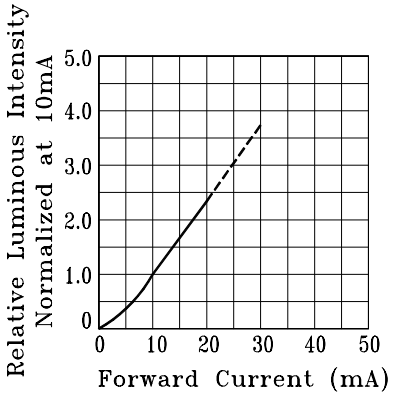


Fig.4 RELATIVE LUMINOUS INTENSITY VS. FORWARD CURRENT

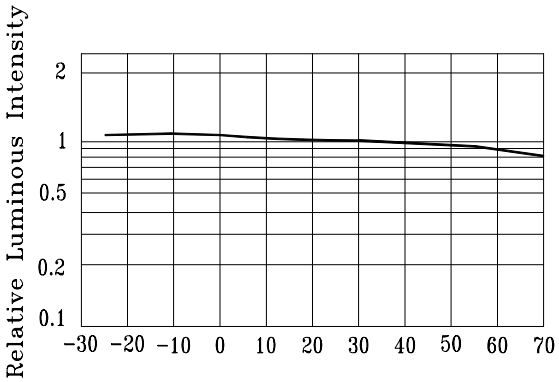


Fig.5 LUMINOUS INTENSITY VS. AMBIENT TEMPERATURE.

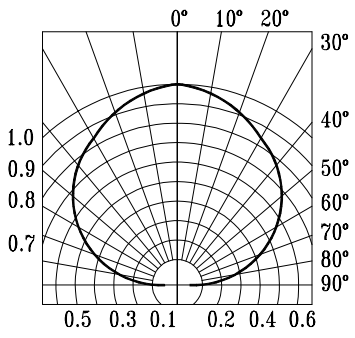
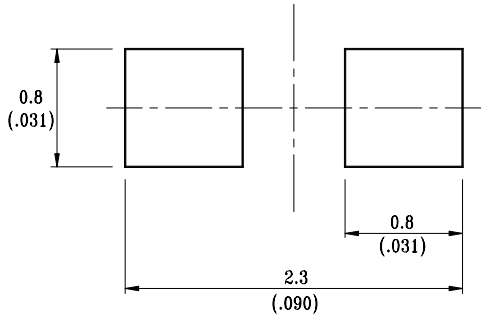


Fig.6 SPATIAL DISTRIBUTION

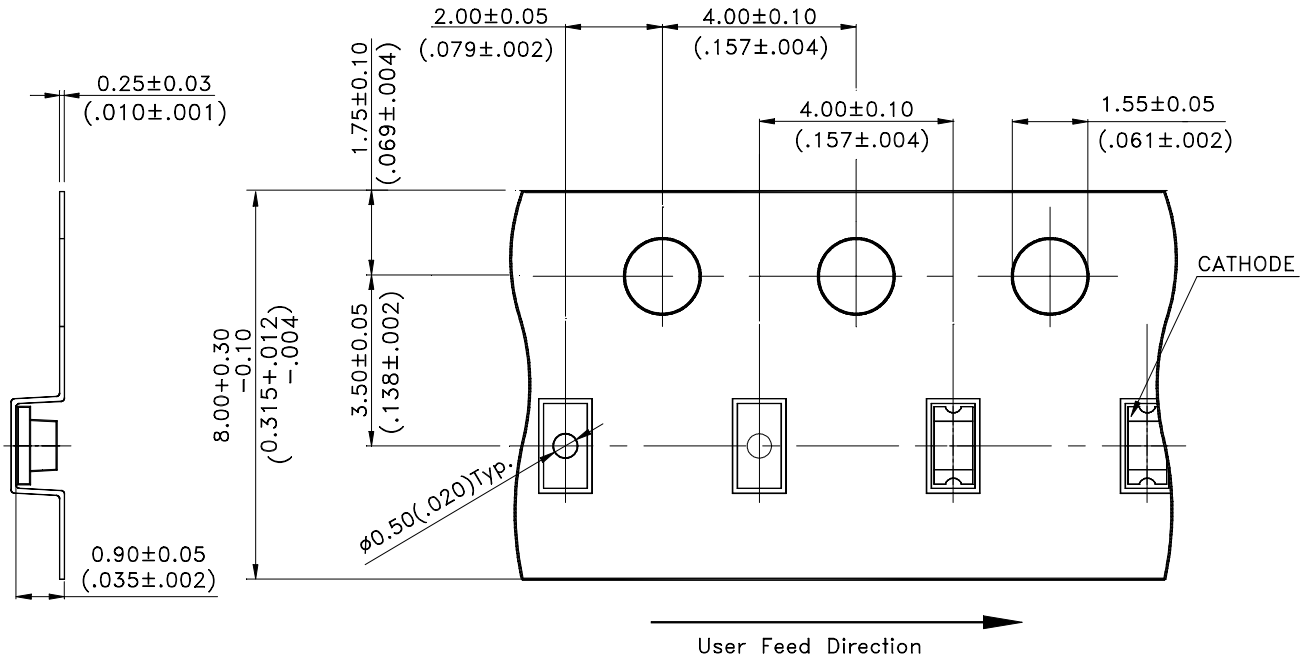
Cleaning

Do not use unspecified chemical liquid to clean LED they could harm the package.
If clean is necessary, immerse the LED in ethyl alcohol or in isopropyl alcohol at normal temperature for less one minute.

Suggest Soldering Pad Dimensions

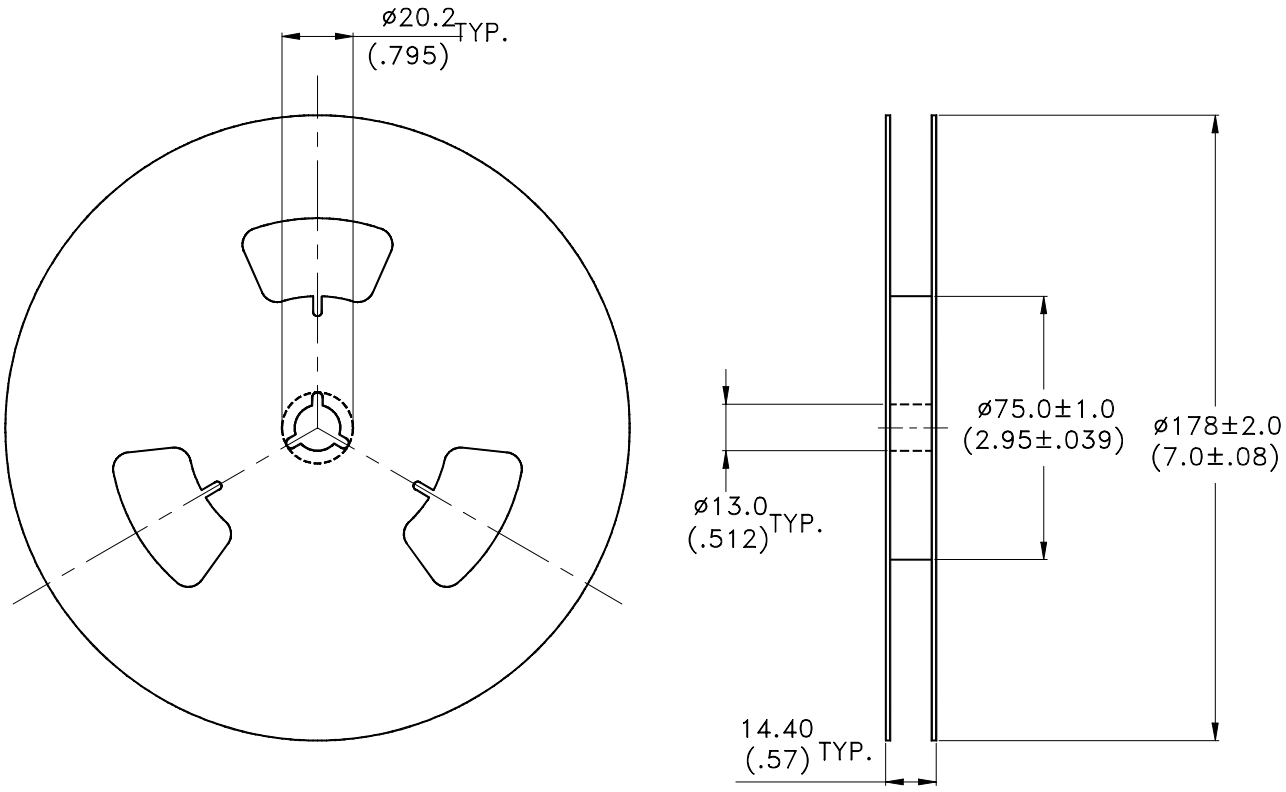


Package Dimensions Of Tape And Reel



Notes:

1. All dimensions are in millimeters (inches).



Notes:

1. Empty component pockets sealed with top cover tape.
2. 7 inch reel-3000 pieces per reel.
3. Minimum packing quantity is 500 pcs for remainders.
4. The maximum number of consecutive missing lamps is two.
5. In accordance with ANSI/EIA 481-1-A-1994 specifications.

CAUTIONS

1. Application limitation

The LEDs described here are intended to be used for ordinary electronic equipment (such as office equipment, communication equipment and household application.) Consult Liteon's sales in advance for information on application in which exceptional quality and reliability are required, particularly when the failure or malfunction of the LEDs may directly jeopardize life or health (such as airplanes, automobiles, traffic control equipment, life support system and safety devices).

2. Storage

Before opening the package : The LEDs should be kept at 30°C or less and 85%RH or less. The LEDs should be used within a year.

After opening the package : The LEDs should be kept at 30°C or less and 70%RH or less. The LEDs should be soldered within 168 hours(7 days) after opening the package.

Please avoid rapid transitions in ambient temperature in high humidity environments where condensation may occur.

3. Cleaning

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED.

4. Soldering

Do not apply any stress to the lead frame during soldering while the LED is at high temperature.

Recommended soldering condition

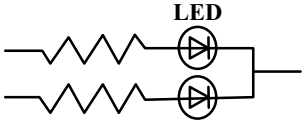
Reflow soldering		Soldering iron		Wave soldering	
Pre-heat Pre-heat time Peak temperature Soldering time	120~150°C 120 sec. Max. 240°C Max. 10 sec. Max.	Temperature Soldering time	300°C Max. 3 sec. Max. (one time only)	Pre-heat Pre-heat time Solder wave Soldering time	100°C Max. 60 sec. Max. 260°C Max. 10 sec. Max.

5. Drive Method

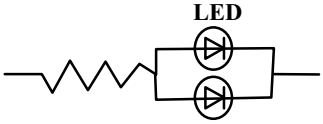
LED is a current operated device, and therefore, requires some kind of current limiting incorporated into the drive circuit. This current limiting typically takes the form of a current limiter resistor placed in series with the LED.

Consider worst case voltage variations that could occur across the current limiting resistor. The forward current should not be allowed to change by more than 40% of its desired value.

Circuit model A



Circuit model B



(A) Recommended circuit.

(B) The difference of brightness between LEDs could be found due to the Vf-If characteristics of LED.

6. ESD (Electrostatic Discharge)

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrostatic glove is recommended when handling these LED. All devices, equipment and machinery must be properly grounded.

7. Reliability Test

Classification	Test Item	Test Condition	Referance Standard
Endurance Test	Operation Life	Ta= Under Room Temperature As Per Data Sheet Maximum Rating *Test Time= 1000HRS (-24HRS,+72HRS)*@20mA.	MIL-STD-750D:1026 (1995) MIL-STD-883D:1005 (1991) JIS C 7021:B-1 (1982)
	High Temperature High Humidity Storage	IR-Reflow In-Board, 2 Times Ta= 65±5℃,RH= 90～95% *Test Time= 1000HRS±2HRS	MIL-STD-202F:103B(1980) JIS C 7021:B-11(1982)
	High Temperature Storage	Ta= 105±5℃ *Test Time= 1000HRS (-24HRS,+72HRS)	MIL-STD-883D:1008 (1991) JIS C 7021:B-10 (1982)
	Low Temperature Storage	Ta= -55±5℃ *Test Time=1000HRS (-24HRS,+72H RS)	JIS C 7021:B-12 (1982)
Environmental Test	Temperature Cycling	105℃ ～ 25℃ ～ -55℃ ～ 25℃ 30mins 5mins 30mins 5mins 10 Cycles	MIL-STD-202F:107D (1980) MIL-STD-750D:1051(1995) MIL-STD-883D:1010 (1991) JIS C 7021:A-4(1982)
	Thermal Shock	IR-Reflow In-Board, 2 Times 105 ± 5℃ ～ -55℃ ± 5℃ 10mins 10mins 10 Cycles	MIL-STD-202F:107D(1980) MIL-STD-750D:1051(1995) MIL-STD-883D:1011 (1991)
	Solder Resistance	T.sol= 260 ± 5℃ Dwell Time= 10 ± 1secs	MIL-STD-202F:210A(1980) MIL-STD-750D:2031(1995) JIS C 7021:A-1(1982)
	IR-Reflow	Ramp-up rate(183℃ to Peak) +3℃ second max Temp. maintain at 125(±25)℃ 120 seconds max Temp. maintain above 183℃ 60-150 seconds Peak temperature range 235℃+5/-0℃ Time within 5°C of actual Peak Temperature (tp) 10-30 seconds Ramp-down rate +6℃/second max	MIL-STD-750D:2031.2(1995) J-STD-020(1999)
	Solderability	T.sol= 235 ± 5℃ Immersion time 2±0.5 sec Immersion rate 25±2.5 mm/sec Immersion rate 25±2.5 mm/sec Coverage ≧95% of the dipped surface	MIL-STD-202F:208D(1980) MIL-STD-750D:2026(1995) MIL-STD-883D:2003(1991) IEC 68 Part 2-20 JIS C 7021:A-2(1982)

8. Others

The appearance and specifications of the product may be modified for improvement without notice.

Mouser Electronics

Authorized Distributor

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LTST-C190AKT

LifeElectronics
Живое партнерство

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